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FDB0690N1507L N-Channel PowerTrench[®] MOSFET **150 V, 115 A, 6.9 m**Ω

Features

- Max r_{DS(on)} = 6.9 mΩ at V_{GS} = 10 V, I_D = 17 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low R_{DS(on)}
- High Power and Current Handling Capability
- RoHS Compliant

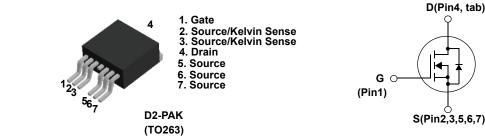
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been especially tailored to minimize the on-state resistance while maintaining superior ruggedness and switching performance for industrial applications.

D(Pin4, tab)

Applications

- Industrial Motor Drive
- Industrial Power Supply
- Industrial Automation
- Battery Operated tools
- Battery Protection
- Solar Inverters
- UPS and Energy Inverters
- Energy Storage
- Load Switch



MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			150	V	
V _{GS}	Gate to Source Voltage			±20	V	
I _D	Drain Current -Continuous	T _C = 25°C	(Note 5)	115		
	-Continuous	T _C = 100°C	(Note 5)	81	Α	
	-Pulsed (Note 4)	636				
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	633	mJ	
	Power Dissipation	T _C = 25°C		250	w	
P _D	Power Dissipation	T _A = 25°C	(Note 1a)	1a) 3.8	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	0.6	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	40	C/VV

Package Marking and Ordering Information

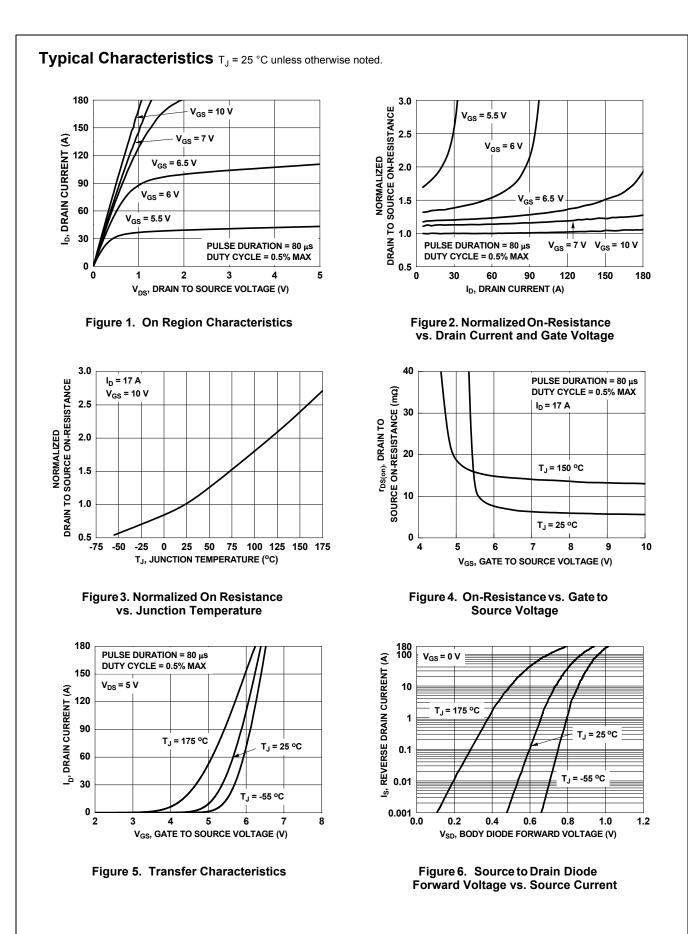
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB0690N1507L	FDB0690N1507L	D2-PAK-7L	330 mm	24 mm	800 units

March 2016

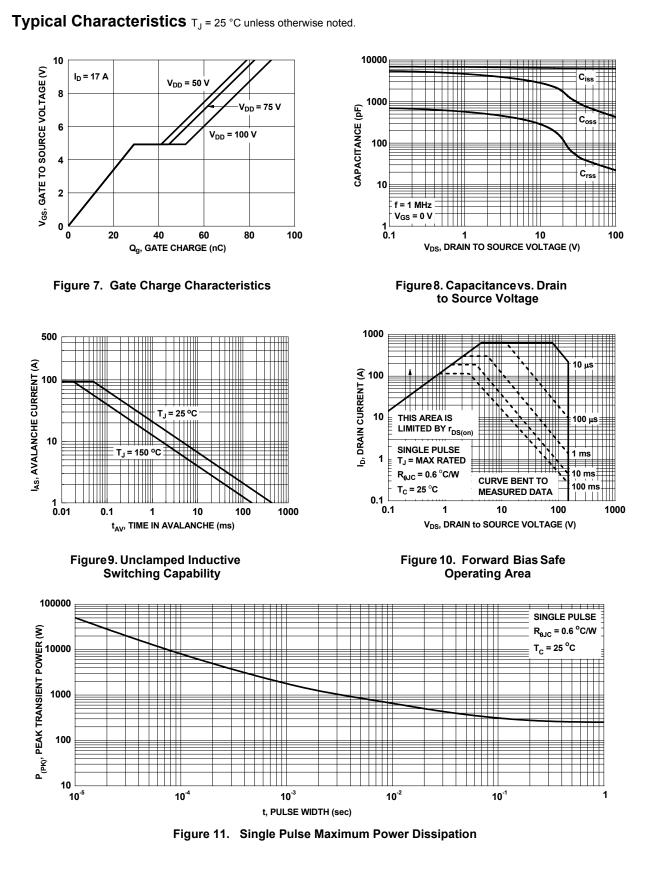
FDB0690N1507L
N-Channel
PowerTrench [®]
MOSFET

Off Chara	Parameter	Test Conditions	Min.	Тур.	Max.	Units
	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_{.1}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{ referenced to } 25 \ ^{\circ}\text{C}$	100	106		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
						1
	ICTERISTICS (Note 2)			1	1	1
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$	2	3.3	4	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 $\mu A,$ referenced to 25 °C		-13		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 17 A		5.4	6.9	mΩ
'DS(on)		V _{GS} = 10 V, I _D = 17 A, T _J = 150°C		12.9	16.5	
9fs	Forward Transconductance	V _{DS} = 10 V, I _D = 17 A		60		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			6265	8775	pF
C _{oss}	Output Capacitance	──V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		502	705	pF
C _{rss}	Reverse Transfer Capacitance			25	40	pF
R _g	Gate Resistance			2.5		Ω
	g Characteristics					
t _{d(on)}	Turn-On Delay Time			35	56	ns
t _r	Rise Time	V _{DD} = 75 V, I _D = 17 A,		30	48	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		53	85	ns
t _f	Fall Time			14	25	ns
Q _g	Total Gate Charge			82	115	nC
Q _{gs}	Gate to Source Gate Charge	$V_{DD} = 75 \text{ V}, \text{ I}_{D} = 17 \text{ A},$		29		nC
Q _{gd}	Gate to Drain "Miller" Charge	V _{GS} = 10 V		15		nC
•	urce Diode Characteristics					
	Maximum Continuous Drain to Source Dio	de Eonward Current		-	115	Α
	Maximum Pulsed Drain to Source Diode F			-	636	A
l _S	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 17 \text{ A}$ (Note 2)	-	0.8	1.2	V
I _{SM}		$v_{GS} = 0 v, v_S = 17 A$ (Note 2)		106	170	ns
I _{SM} V _{SD}	· · ·					
I _{SM}	Reverse Recovery Time Reverse Recovery Charge	— I _F = 17 A, di/dt = 100 A/μs		226	362	nC

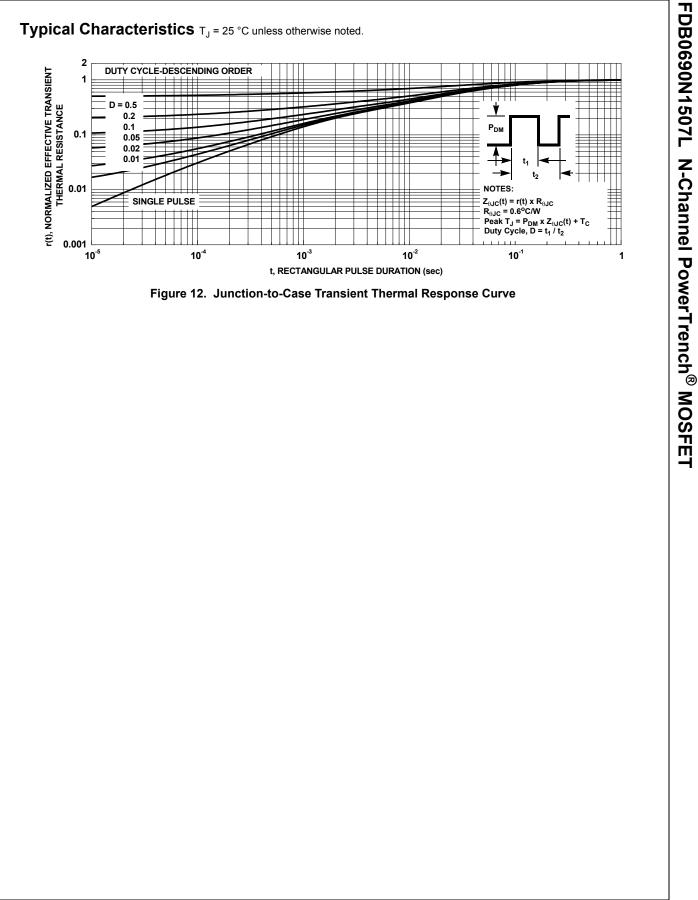
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

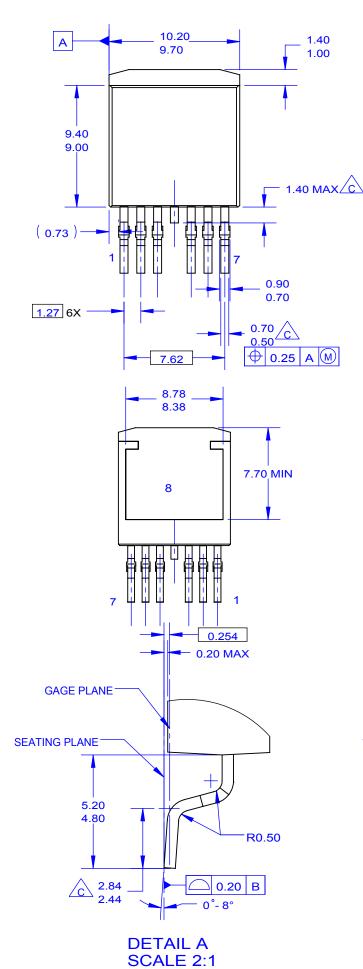


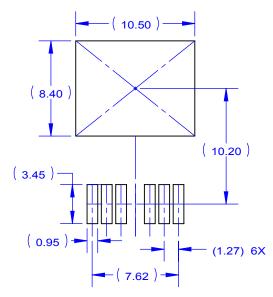
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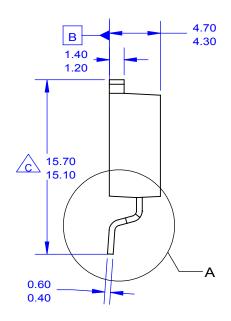
FDB0690N1507L N-Channel PowerTrench[®] MOSFET







LAND PATTERN RECOMMENDATION



NOTES:

- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED.
 B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE. D. DIMENSION AND TOLERANCE AS PER ASME
 - Y14.5-1994. E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
 - F. LAND PATTERN RECOMMENDATION PER IPC. TO127P1524X465-8N.
 - G. DRAWING FILE NAME: TO263A07REV5.

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